APPENDIX A

"CLEAN" VERSION OF EACH PARAGRAPH/SECTION/CLAIM 37 C.F.R. § 1.121(b)(ii) AND (c)(i)

Amend the Following Claims As Follows:

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6. (Amended) The method defined in Claim 3 wherein said solid precursor material is a compound containing a metal selected from the group consisting of molybdenum, niobium, tantalum and tungsten.

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- 10. (Amended) The method defined in Claim 3 wherein said solid precursor material is a compound containing a metal selected from the group consisting of molybdenum, niobium, tantalum and tungsten.
- / 11. (Amended) The method defined in claim I wherein:

said solid precursor is a compound containing a metal selected from the group consisting of molybdenum, niobium, tantalum and tungsten;

said liquid added to said solid precursor-containing bubbler apparatus has a vapor pressure less than 10⁻⁸ Torr at room temperature;

said solid precursor has a solubility in said liquid of less than 1000ppm;

and said substrate to which said precursor is to be applied is selected from the group consisting of silicon, silicon dioxide or silicon nitride;

said carrier gas being either a noble gas or ammonia

12. (Amended) The method defined in Claim 1 wherein said metal in said compound forming said solid precursor is tungsten, said liquid is a silicon oil oligomer and said carrier gas is argon.

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VERSION WITH MARKINGS TO SHOW CHANGES MADE 37 C.F.R. § 1.121(b)(iii) AND (c)(ii)

Amend the Following Claims As Follows:

- 6. (Amended) The method defined in Claim 3 wherein said solid precursor material is a compound containing a metal selected from the group consisting of molybdenum, niobium, tantalum and tungsten.
- 10. (Amended) The method defined in Claim 3 wherein said solid precursor material is a compound containing a metal selected from the group consisting of molybdenum, niobium, tantalum and tungsten.
- 11. (Amended) The method defined in claim 1 wherein:

said solid precursor is a compound containing a metal selected from the group consisting of molybdenum, niobium, tantalum and tungsten;

said liquid added to said solid precursor-containing bubbler apparatus has a vapor pressure less than 10 -8 Torr at room temperature;

said solid precursor has a solubility in said liquid of less than 1000ppm;

and said substrate to which said precursor is to be applied is selected from the group consisting of silicon, silicon dioxide or silicon nitride;

said carrier gas being either a noble gas or ammonia

12. (Amended) The method defined in Claim 1 wherein said metal in said compound forming said solid precursor is tungsten, said liquid is a silicon oil oligomer and said carrier gas is argon.

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